APPLIC <i>A</i>	BLE STAN	IDARD										
OPERATING TEMPERATUR		RE RANGE	-35°C TO +85°C(NO	OTE 1)		PERATU	IRE RANGE		-10°C TO +60°C(ľ	NOTE	3)	
RATING	OPERATING HUMIDITY RANGE		40 % TO 80 % (NC	TE 2)	STOR HUMI	RAGE DITY RA	ANGE		40 % TO 70 %(NO		3)	
CURRENT		Γ	1 A/pin			LTAGE			150 V AC (DC)			
	APPLICABLE CONNECTOR		DE14-"5-1750			PLICABLE DF			DF14-***S0	14-****SCF		
	CONNECTOR		SPEC	IFICA								
	ТЕМ		TEST METHOD	11 10/1		10	DE		REMENTS	QT	АТ	
	RUCTION		TEST WETHOD				KE	QUII	KEMENTS	Q I	AI	
GENERAL EXAMINATION		VISUALLY AND BY MEASURING INSTRUMENT.				ACCORDING TO DRAWING.				X	Х	
MARKING		CONFIRMED VISUALLY.				1				X		
FL FCTR	IC CHARA	CTERI	STICS									
	RESISTANCE	20 mV MAX, 1mA (DC OR 1000 Hz)				30 mΩ MAX.					Τ_	
INSULATION		100 V DC.			:	500 MΩ MIN.				X		
RESISTANCE										Х		
VOLTAGE PROOF		500 V AC FOR 1 min.				NO FLASHOVER OR BREAKDOWN.				Х	_	
MECHAI	VICAL CH											
MECHANICAL OPERATION		30 TIMES INSERTIONS AND EXTRACTIONS.				1) CONTACT RESISTANCE: 30 mΩ MAX. 2) NO DAMAGE, CRACK OR LOOSENESS OF PARTS.				- X	_	
VIBRATION		0.75 mm, AT 2 h, FOR 3 DIRECTIONS.				1) NO ELECTRICAL DISCONTINUITY OF 1μs. 2) NO DAMAGE, CRACK OR LOOSENESS OF					_	
SHOCK		490 m/s ² DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.				PARTS.						
			ACTERISTICS			١١ ٥٥١١			1105 00 01111	1	1	
RAPID CHANGE OF TEMPERATURE		TIME $30 \rightarrow 10 \text{ TO } 15 \rightarrow 30 \rightarrow 10 \text{ TO } 15 \text{ min.}$ UNDER 5 CYCLES.			5 min.	1) CONTACT RESISTANCE: 30 mΩ MAX. 2) INSULATION RESISTANCE: 500 MΩ MIN. 3) NO DAMAGE, CRACK OR LOOSENESS OF PARTS.					-	
DAMP HEAT (STEADY STATE)			EXPOSED AT 40±2 °C, 90 ~ 95 %, 96 h.									
RESISTANCE TO SOLDERING HEAT		1) REFLOW SOLDERING «REFLOW AREA» MAX 250°C WITHIN 10 sec MIN 230°C WITHIN 60 sec «PREHEATING AREA» 170°C to 190°C 60 sec To 120 sec PUT THROUGH IN REFLOW FUMACE TWICE. LEAVE IN AMBIENT TEMPERATURE AND HUMIDITY FOR 1 HOUR. CONNECTOR TEMPERTURE TO BE AMBIENT FOR SECOND REFLOW. 2) MANUAL SOLDERING SOLDERING IRON TEMPERATURE 350±5°C, FOR 5±1 sec. NO STRENGTH ON CONTACT.			NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.							
SOLDERABILITY		SOLDERING TEMPERATURE : 245±5°C DURATION OF IMMERSION :				A NEW UNIFORM COATING OF SOLDER SHALL COVER MINIMUM OF 95 % OF THE						
NOTE2: NO (NOTE3: APPI	CONDENSING LY TO THE CON	SOLDER MPERATUR	ING, FOR 3 sec. RE RISE BY CURRENT. LONG TERM STORAGE FOR UNITED TO THE LONG TEMPERATURE AND HUMIN		RODUCT	SURFA	CE BEING	IMM	ERSED.	X		
COUN	IT DE	SCRIPTI	ON OF REVISIONS		DESIG				CHECKED	D	ATE	
Δ												
Unless ot	herwise spe	ecified, re	cified, refer to IEC 60512.			APPROVED CHECKED		ΞD	HS.OKAWA			
								D	TS.KUMAZAWA			
							DESIGNE	D	HK.HAYASHI	202	00316	
						DRAWN		ı	DS.HIROWATARI 202		00311	
Note QT:0	Qualification Te	ssurance Test X:Applicable T	ole Test D		RAWING NO.			ELC-160307-22-00				
HS.			ECIFICATION SHEET			PART NO.		DF14-*P-1.25H(22)				
L= =		OSE E	OSE ELECTRIC CO., LTD.		CODE NO.			CL538 🔼				